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"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded - Microcontrollers</u>"

- · ·	
Details	
Product Status	Not For New Designs
Core Processor	R8C
Core Size	16-Bit
Speed	16MHz
Connectivity	I ² C, LINbus, SIO, SSU, UART/USART
Peripherals	LED, POR, Voltage Detect, WDT
Number of I/O	13
Program Memory Size	16KB (16K x 8)
Program Memory Type	FLASH
EEPROM Size	2K x 8
RAM Size	1K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	A/D 4x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	20-LSSOP (0.173", 4.40mm Width)
Supplier Device Package	20-LSSOP
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f21294ksp-w4

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R8C/28 Group, R8C/29 Group SINGLE-CHIP 16-BIT CMOS MCU

REJ03B0169-0210 Rev.2.10 Sep 26, 2008

1. Overview

These MCUs are fabricated using a high-performance silicon gate CMOS process, embedding the R8C CPU core, and are packaged in a 20-pin molded-plastic LSSOP. It implements sophisticated instructions for a high level of instruction efficiency. With 1 Mbyte of address space, they are capable of executing instructions at high speed.

Furthermore, the R8C/29 Group has on-chip data flash (1 KB \times 2 blocks).

The difference between the R8C/28 Group and R8C/29 Group is only the presence or absence of data flash. Their peripheral functions are the same.

1.1 Applications

Electronic household appliances, office equipment, audio equipment, consumer products, automotive, etc.



1.4 Product Information

Table 1.3 lists the Product Information for R8C/28 Group and Table 1.4 lists the Product Information for R8C/29 Group.

Table 1.3 Product Information for R8C/28 Group

Current of Sep. 2008

Type No.	ROM	RAM	Package Type	Pon	narks	
Type No.	Capacity	Capacity	r ackage Type	IXen	liains	
R5F21282SNSP	8 Kbytes	512 bytes	PLSP0020JB-A	N version		
R5F21284SNSP	16 Kbytes	1 Kbyte	PLSP0020JB-A			
R5F21282SDSP	8 Kbytes	512 bytes	PLSP0020JB-A	D version		
R5F21284SDSP	16 Kbytes	1 Kbyte	PLSP0020JB-A			
R5F21284JSP	16 Kbytes	1 Kbyte	PLSP0020JB-A	J version		
R5F21286JSP	32 Kbytes	1.5 Kbyte	PLSP0020JB-A			
R5F21284KSP	16 Kbytes	1 Kbyte	PLSP0020JB-A	K version		
R5F21286KSP	32 Kbytes	1.5 Kbyte	PLSP0020JB-A			
R5F21282SNXXXSP	8 Kbytes	512 bytes	PLSP0020JB-A	N version	Factory	
R5F21284SNXXXSP	16 Kbytes	1 Kbyte	PLSP0020JB-A		programming	
R5F21282SDXXXSP	8 Kbytes	512 bytes	PLSP0020JB-A	D version	product ⁽¹⁾	
R5F21284SDXXXSP	16 Kbytes	1 Kbyte	PLSP0020JB-A			
R5F21284JXXXSP	16 Kbytes	1 Kbyte	PLSP0020JB-A	J version		
R5F21286JXXXSP	32 Kbytes	1.5 Kbyte	PLSP0020JB-A]		
R5F21284KXXXSP	16 Kbytes	1 Kbyte	PLSP0020JB-A	K version		
R5F21286KXXXSP	32 Kbytes	1.5 Kbyte	PLSP0020JB-A			

NOTE:

1. The user ROM is programmed before shipment.

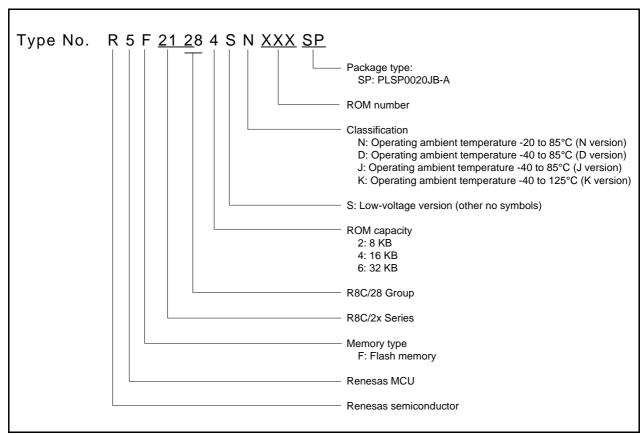


Figure 1.2 Type Number, Memory Size, and Package of R8C/28 Group

Table 1.4 Product Information for R8C/29 Group

Current of Sep. 2008

	ROM (Capacity	RAM				
Type No.	Program ROM	Data flash	Capacity	Package Type	Re	marks	
R5F21292SNSP	8 Kbytes	1 Kbyte x 2	512 bytes	PLSP0020JB-A	N version		
R5F21294SNSP	16 Kbytes	1 Kbyte x 2	1 Kbyte	PLSP0020JB-A			
R5F21292SDSP	8 Kbytes	1 Kbyte x 2	512 bytes	PLSP0020JB-A	D version		
R5F21294SDSP	16 Kbytes	1 Kbyte x 2	1 Kbyte	PLSP0020JB-A			
R5F21294JSP	16 Kbytes	1 Kbyte x 2	1 Kbyte	PLSP0020JB-A	J version		
R5F21296JSP	32 Kbytes	1 Kbyte x 2	1.5 Kbyte	PLSP0020JB-A			
R5F21294KSP	16 Kbytes	1 Kbyte x 2	1 Kbyte	PLSP0020JB-A	K version		
R5F21296KSP	32 Kbytes	1 Kbyte x 2	1.5 Kbyte	PLSP0020JB-A			
R5F21292SNXXXSP	8 Kbytes	1 Kbyte x 2	512 bytes	PLSP0020JB-A	N version	Factory	
R5F21294SNXXXSP	16 Kbytes	1 Kbyte x 2	1 Kbyte	PLSP0020JB-A		programming	
R5F21292SDXXXSP	8 Kbytes	1 Kbyte x 2	512 bytes	PLSP0020JB-A	D version	product ⁽¹⁾	
R5F21294SDXXXSP	16 Kbytes	1 Kbyte x 2	1 Kbyte	PLSP0020JB-A			
R5F21294JXXXSP	16 Kbytes	1 Kbyte x 2	1 Kbyte	PLSP0020JB-A	J version	1	
R5F21296JXXXSP	32 Kbytes	1 Kbyte x 2	1.5 Kbyte	PLSP0020JB-A			
R5F21294KXXXSP	16 Kbytes	1 Kbyte x 2	1 Kbyte	PLSP0020JB-A	K version	1	
R5F21296KXXXSP	32 Kbytes	1 Kbyte x 2	1.5 Kbyte	PLSP0020JB-A			

NOTE:

1. The user ROM is programmed before shipment.

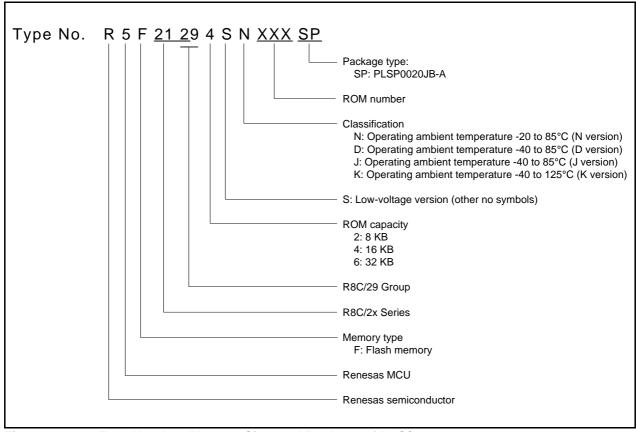


Figure 1.3 Type Number, Memory Size, and Package of R8C/29 Group

1.6 **Pin Functions**

Table 1.5 lists Pin Functions.

Table 1.5 **Pin Functions**

Туре	Symbol	I/O Type	Description
Power supply input	VCC, VSS	I	Apply 2.2 to 5.5 V (J, K version are 2.7 to 5.5 V) to the VCC pin. Apply 0 V to the VSS pin.
Analog power supply input	AVCC, AVSS	I	Power supply for the A/D converter. Connect a capacitor between AVCC and AVSS.
Reset input	RESET	I	Input "L" on this pin resets the MCU.
MODE	MODE	I	Connect this pin to VCC via a resistor.
XIN clock input	XIN	I	These pins are provided for XIN clock generation circuit I/O. Connect a ceramic resonator or a crystal oscillator between
XIN clock output	XOUT	0	the XIN and XOUT pins. To use an external clock, input it to the XIN pin and leave the XOUT pin open.
XCIN clock input (N, D version)	XCIN	I	These pins are provided for XCIN clock generation circuit I/O. Connect a crystal oscillator between the XCIN and XCOUT
XCIN clock output (N, D version)	XCOUT	0	pins. To use an external clock, input it to the XCIN pin and leave the XCOUT pin open.
INT interrupt input	ĪNTO, ĪNT1, ĪNT3	I	INT interrupt input pins
Key input interrupt	KI0 to KI3	I	Key input interrupt input pins
Timer RA	TRAO	0	Timer RA output pin
	TRAIO	I/O	Timer RA I/O pin
Timer RB	TRBO	0	Timer RB output pin
Timer RC	TRCCLK	I	External clock input pin
	TRCTRG	I	External trigger input pin
	TRCIOA, TRCIOB, TRCIOC, TRCIOD	I/O	Sharing output-compare output / input-capture input / PWM / PWM2 output pins
Serial interface	CLK0	I/O	Clock I/O pin
	RXD0, RXD1	I	Receive data input pin
	TXD0, TXD1	0	Transmit data output pin
I ² C bus interface	SCL	I/O	Clock I/O pin
	SDA	I/O	Data I/O pin
Clock synchronous	SSI	I/O	Data I/O pin
serial I/O with chip	SCS	I/O	Chip-select signal I/O pin
select	SSCK	I/O	Clock I/O pin
	SSO	I/O	Data I/O pin
Reference voltage input	VREF	I	Reference voltage input pin to A/D converter
A/D converter	AN8 to AN11	I	Analog input pins to A/D converter
I/O port	P1_0 to P1_7, P3_3 to P3_5, P3_7, P4_5	I/O	CMOS I/O ports. Each port has an I/O select direction register, allowing each pin in the port to be directed for input or output individually. Any port set to input can be set to use a pull-up resistor or not by a program. P1_0 to P1_7 also function as LED drive ports (N, D version).
Input port	P4_2, P4_6, P4_7	ı	Input-only ports
put put	· ·_ - , · ·_ - ,	<u>'</u>	In the county beare

I: Input

O: Output

I/O: Input and output



Table 1.6 Pin Name Information by Pin Number

			I/O Pin Functions for of Peripheral Modules					
Pin Number	Control Pin	Port	Interrupt	Timer	Serial Interface	Clock Synchronous Serial I/O with Chip Select	I ² C bus Interface	A/D Converter
1		P3_5		TRCIOD		SSCK	SCL	
2		P3_7		TRAO	RXD1/(TXD1) ⁽¹⁾	SSO		
3	RESET							
4	XOUT/ XCOUT ⁽²⁾	P4_7						
5	VSS/AVSS							
6	XIN/XCIN(2)	P4_6						
7	VCC/AVCC							
8	MODE							
9		P4_5	ĪNT0		(RXD1) ⁽¹⁾			
10		P1_7	INT1	TRAIO				
11		P1_6			CLK0	(SSI) ⁽¹⁾		
12		P1_5	(INT1) ⁽¹⁾	(TRAIO) ⁽¹⁾	RXD0			
13		P1_4			TXD0			
14		P1_3	KI3	TRBO				AN11
15		P1_2	KI2	TRCIOB				AN10
16	VRFF	P4_2						
17		P1_1	KI1	TRCIOA/ TRCTRG				AN9
18		P1_0	KI0					AN8
19		P3_3	ĪNT3	TRCCLK		SSI		
20		P3_4		TRCIOC		SCS	SDA	

- 1. This can be assigned to the pin in parentheses by a program.
- 2. XCIN, XCOUT can be used only for N or D version.

2. Central Processing Unit (CPU)

Figure 2.1 shows the CPU Registers. The CPU contains 13 registers. R0, R1, R2, R3, A0, A1, and FB configure a register bank. There are two sets of register bank.

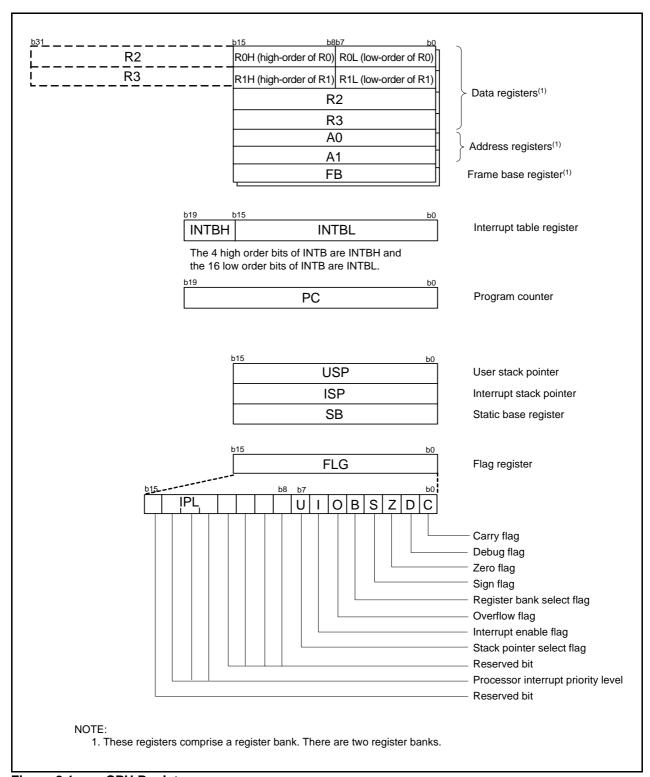


Figure 2.1 CPU Registers

SFR Information (5)⁽¹⁾ Table 4.5

Address	Register	Symbol	After reset
0100h	Timer RA Control Register	TRACR	00h
0101h	Timer RA I/O Control Register	TRAIOC	00h
0102h	Timer RA Mode Register	TRAMR	00h
0103h	Timer RA Prescaler Register	TRAPRE	FFh
0104h	Timer RA Register	TRA	FFh
0105h			
0106h	LIN Control Register	LINCR	00h
0100h	LIN Status Register	LINST	00h
	Lin Status Register		
0108h	Timer RB Control Register	TRBCR	00h
0109h	Timer RB One-Shot Control Register	TRBOCR	00h
010Ah	Timer RB I/O Control Register	TRBIOC	00h
010Bh	Timer RB Mode Register	TRBMR	00h
010Ch	Timer RB Prescaler Register	TRBPRE	FFh
010Dh	Timer RB Secondary Register	TRBSC	FFh
010Eh	Timer RB Primary Register	TRBPR	FFh
010Fh	Timer No Filmary Register	TRBLIX	
0110h			
0111h			
0112h			
0113h			
0114h			
0115h			
0116h			
0117h			
	Times DE Coond Date Degister / Country Date Degister	TDECEC	006
0118h	Timer RE Second Data Register / Counter Data Register	TRESEC	00h
0119h	Timer RE Minute Data Register / Compare Data Register	TREMIN	00h
011Ah	Timer RE Hour Data Register ⁽²⁾	TREHR	00h
011Bh	Timer RE Day of Week Data Register(2)	TREWK	00h
011Ch	Timer RE Control Register 1	TRECR1	00h
011Dh	Timer RE Control Register 2	TRECR2	00h
011Eh	Timer RE Count Source Select Register	TRECSR	00001000b
011Fh			
0120h	Timer RC Mode Register	TRCMR	01001000b
0121h	Timer RC Control Register 1	TRCCR1	00h
0122h	Timer RC Interrupt Enable Register	TRCIER	01110000b
0123h	Timer RC Status Register	TRCSR	01110000b
0124h	Timer RC I/O Control Register 0	TRCIOR0	10001000b
0125h	Timer RC I/O Control Register 1	TRCIOR1	10001000b
0126h	Timer RC Counter	TRC	00h
	Timer RC Counter	IRC	
0127h			00h
0128h	Timer RC General Register A	TRCGRA	FFh
0129h			FFh
012Ah	Timer RC General Register B	TRCGRB	FFh
012Bh			FFh
012Ch	Timer RC General Register C	TRCGRC	FFh
012Dh			FFh
012Bh	Timer RC General Register D	TRCGRD	FFh
012EII	Time: No Selieral Negister D	TACGRE	FFh
	T. DOO . ID I . O	TD00D0	
0130h	Timer RC Control Register 2	TRCCR2	00011111b
0131h			00h
N122h	Timer RC Digital Filter Function Select Register	TRCDF	
0132h	Timer RC Digital Filter Function Select Register Timer RC Output Master Enable Register	TRCOER	01111111b
013211 0133h		_	01111111b
		_	01111111b
0133h		_	01111111b
0133h 0134h 0135h		_	01111111b
0133h 0134h 0135h 0136h		_	01111111b
0133h 0134h 0135h 0136h 0137h		_	01111111b
0133h 0134h 0135h 0136h 0137h 0138h		_	01111111b
0133h 0134h 0135h 0136h 0137h 0138h 0139h		_	01111111b
0133h 0134h 0135h 0136h 0137h 0138h 0139h 013Ah		_	01111111b
0133h 0134h 0135h 0136h 0137h 0138h 0139h		_	01111111b
0133h 0134h 0135h 0136h 0137h 0138h 0139h 013Ah		_	01111111b
0133h 0134h 0135h 0136h 0137h 0138h 0139h 013Ah 013Bh 013Ch		_	01111111b
0133h 0134h 0135h 0136h 0137h 0138h 0139h 013Ah 013Bh 013Ch 013Dh		_	01111111b
0133h 0134h 0135h 0136h 0137h 0138h 0139h 013Ah 013Bh 013Ch		_	01111111b

- The blank regions are reserved. Do not access locations in these regions.
 In J, K version these regions are reserved. Do not access locations in these regions.

SFR Information (6)⁽¹⁾ Table 4.6

Address	Register	Symbol	After reset
0140h	rogiotor	Cymbol	7110110001
0141h			
0142h			
0143h			
0144h			
0145h			
0146h			
0147h			
0148h			
0149h			
014Ah			
014Bh			
014Ch			
014Dh			
014Eh			
014Fh			
0150h			
0151h			
0152h			
0153h			
0154h			
0155h			
0156h			
0157h			
0158h 0159h			
0159fi 015Ah			
015An			
015Ch			
015Dh			
015Eh			
015Fh			
0160h			
0161h			
0162h			
0163h			
0164h			
0165h			
0166h			
0167h			
0168h			
0169h			
016Ah			
016Bh			
016Ch			
016Dh			
016Eh			
016Fh			
0170h			
0171h			
0172h			
0173h			
0174h 0175h			
0175h 0176h			
0176H 0177h			
017711 0178h			
0176H			
017911 017Ah			
017An			
017Ch			
017Ch			
017Eh			
017En			
NOTE:	1		l

NOTE:

1. The blank regions are reserved. Do not access locations in these regions.

Table 4.7 SFR Information (7)⁽¹⁾

0180h 0182h 0183h 0184h 0184h 0184h 0186h	Address	Register	Symbol	After reset
0181h 0183h 0183h 0183h 0188h		Trogistics	Cymise.	7.11.01.10001
0182h 0184h 0184h 0186h 0186h 0186h 0186h 0188h				
0183h 0185h 0186h 0186h 0187h 0188h				
0194h 0198h	0183h			
0188h 0187h 0188h 0198h 0198h 0199h				
0186h 0188h 0188h 018Ah 018Ah 018Ah 018Ch 019Ch				
0187h 0188h 018Ch 018Ch 018Ch 018Ch 018Ch 018Ch 018Ch 018Ch 019Ch	0186h			
0188h 018Ah 018Ah 018Ch 018Ch 018Ch 018Ch 018Ch 018Ch 018Ch 018Ch 019Ch 019Ch 019Ch 019Ch 019Sh 019Ch				
0188h 0188h 0188h 0188h 0188h 0188h 0188h 018Fh 018Fh 018Fh 018Fh 018Fh 0197h				
018Ah 018Ch 018Ch 018Ch 018Ch 018Eh 018Ch 018Eh 019Ch 019Ch 019Ch 019Ch 019Ch 019Sh 019Ah 019Ah 019Ah 019Ah 019Ch	0189h			
018Bh 018Ch 018Ch 018Fh 018Fh 019Ph 0191h 0191h 0193h 0193h 0195h 0198h 0188h	018Ah			
018Ch	018Rh			
018Eh 018Ph 018Ph 019Ph 0191h 0191h 0193h 0193h 0198h 0118h 011Ah 011Ah 011Ah 011Ah 011Ah 01Ah 01A				
018Eh 019Dh 019Dh 019Dh 019Zh 019Zh 019Zh 019Sh				
018Ph 0190h 0191h 0191h 0192h 0193h 0194h 0195h 0195h 0196h 0197h 0197h 0197h 0198h 0148h 0158h 0158h 0168h 0168h 0178h 018h 018h 018h 018h 018h 018h 018h 01				
0190h (192h 0192h (192h 0194h (198h) 0196h (198h) 0197h (198h) 0198h (199h) 0199h (199h) 0190h (190h) 0190h (190h) 0191h (190h) 0192h (190h) 0194h (190h) 0195h (190h) 0196h (190h) 0197h (190h) 0198h (190h) 0197h (190h) 0198h (190h) 0142h (190h) 0143h (191h) 0143h (191h) 0148h (191h) 0189h (191h)	018Fh			
0191h 0193h 0193h 0194h 0195h 0196h 0197h 0197h 0197h 0197h 0198h 0147h 0147h 0148h 0147h 0148h 0147h 0148h 0147h 0148h 0148h 0148h 0148h 0148h 0148h 0148h 0148h 0148h 0158h 0148h 0158h 0148h 0158h 0148h 0158h 0158h 0158h 0168h 0168h 0168h 0188h				
0192h 0193h 0194h 0195h 0196h 0196h 0197h 0198h 0199h 0199h 0199h 0199h 0199h 0199h 0199h 0199h 0199h 0190h 0191h 0190h 0191h 0190h 0191h 010h 0140h 0140h 0141h 0143h 0143h 0148h 0158h 0148h 0158h 0158h 0168h 0168h 0168h 018h 018h 018h 018h 018h 018h 018h 01				
0193h 0195h 0195h 0197h 0198h 0197h 0198h 0199h 0198h 0140h 0140h 0141h 0142h 0143h 0148h 0158h 0158h 0168h 018h 018h 018h 018h 018h 018h 018h 01	0191h			
0194h 0195h 0197h 0198h 0197h 0198h 0199h 0199h 0199h 0199h 019bh 019bh 019bh 019bh 014bh				
0195h (197h 0197h (197h) 0198h (198h) 0199h (19Ah) 0198h (19Bh) 019Ch (19Ch) 019Dh (19Dh) 019Eh (19Fh) 0140h (19Fh) 01A0h (10Ah) 01A1h (10Ah) 01A2h (10Ah) 01A3h (10Ah) 01A4h (10Ah) 01A4h (10Ah) 01A6h (10Ah) 01A7h (10Ah) 01A8h (10Ah) 01A9h (10Ah) 01A0h (10Ah) 01A2h (10Ah)				
0198h 0198h 0199h 0199h 0199h 0199h 0199h 0199h 019Bh 019Dh 019Eh 019Fh 0140h 01A1h 01A2h 01A3h 01A3h 01A4h 01A5h 01A5h 01A6h 01A7h 01A8h 01A7h 01A8h 01A9h 01B9h				
0197h 0198h 0199h 019Ah 019Bh 019Ch 019Ch 019Ch 019Eh 019Eh 0140h 01A0h 01A0h 01A1h 01A2h 01A3h 01A3h 01A4h 01A5h 01A7h 01A8h 01A7h 01A8h 01A9h 01AAh 01ABh 01ACh 01ABh 01ACh 01ADh 01AFh 01AFh 01B1h 01B1h 01B2h Flash Memory Control Register 4 01B3h Flash Memory Control Register 1 FMR1 01B8h 01B8h 01B8h FMR0 00000001b 01B8h 01B8h 01B8h 01B8h 01B0h 0000001b 01B8h 01B0h 0000001b 01B8h 01B0h 0000001b				
0198h 0199h 0199h 0199h 0199h 019Ph 019Dh 019Ph 019Ph 019Ph 010Ph				
0199h 0198h 019Bh 019Ch 019Dh 019Eh 019Fh 014Ph 01A0h 01A1h 01A2h 01A3h 01A3h 01A3h 01A3h 01A3h 01A6h 01A7h 01A8h 01A8h 01A8h 01A8h 01A8h 01A8h 01ABh 01ABh 01ACh 01ABh 01ACh 01AFh 01Bh 01Bh 01Bh Flash Memory Control Register 4 01Bh Flash Memory Control Register 1 01Bh Flash Memory Control Register 0 01Bh 01Bh 01Bh Flash Memory Control Register 0 01Bh Flash Memory Control Register 0 01Bh Flash Memory Control Register 0 01Bh 00000001b 01Bh 01Bh 01Bh 01Bh 01Bh 01Bh 01Bh 01Bh 01Bh 01Bh	019/11			
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019Bh 019Ch 019Dh 019Eh 019Fh 01A0h 01A0h 01A1h 01A2h 01A3h 01A3h 01A6h 01A6h 01A7h 01A8h 01A8h 01A8h 01A8h 01A8h 01A8h 01A8h 01ABh 01BBh				
019Ch	019AII			
019Dh				
019Eh 019Fh 01A0h 01A1h 01A2h 01A3h 01A3h 01A4h 01A6h 01A6h 01A8h 01A7h 01A8h 01A9h 01A8h 01A8h 01AAh 01ABh 01ACh 01ADh 01ACh 01ADh 01AEh 01AEh 01ABh 01Bh 01Bh 01Bh				
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01B5h Flash Memory Control Register 1 FMR1 1000000Xb 01B6h 01B7h Flash Memory Control Register 0 FMR0 00000001b 01B8h 01B9h 01BAh 01BBh 01BCh 01BCh 01BDh 01BEh 01BEh 01BBh 01BEh 01BBh 01BBh		Flash Memory Control Register 4	FMR4	01000000b
01B6h 01B7h Flash Memory Control Register 0 FMR0 00000001b 01B8h 01B9h 01BAh 01BBh 01BCh 01BDh 01BBh 01BBh 01BCh 01BBh 01BBh 01BBh 01BBh 01BBh 01BBh 01BBh	01B4h			
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01B7h Flash Memory Control Register 0 FMR0 00000001b 01B8h 01B9h 01B4h 01B4h 01B6h 01BBh 01BCh 01BCh 01BDh 01BBh 01BBh	01B6h			
01B9h 01BAh 01BBh 01BCh 01BDh 01BEh	01B7h	Flash Memory Control Register 0	FMR0	00000001b
01B9h 01BAh 01BBh 01BCh 01BDh 01BEh	01B8h			
01BAh 01BBh 01BCh 01BDh 01BBh	01B9h			
01BBh 01BCh 01BDh 01BEh	01BAh			
01BCh	01BBh			
01BDh	01BCh			
01BEh	01BDh			
01BFh	01BEh			
	01BFh			
	<u> </u>	I .	l	<u> </u>

FFFFh X: Undefined

NOTES:

1. The blank regions are reserved. Do not access locations in these regions.

Option Function Select Register

2. The OFS register cannot be changed by a program. Use a flash programmer to write to it.

OFS

(Note 2)

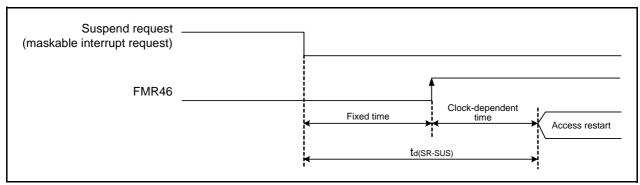


Figure 5.2 Time delay until Suspend

Table 5.6 **Voltage Detection 0 Circuit Electrical Characteristics**

Symbol	Parameter	Condition		Unit		
Syllibol	Falametei	Condition	Min.	Тур.	Max.	Offic
Vdet0	Voltage detection level		2.2	2.3	2.4	V
=	Voltage detection circuit self power consumption	VCA25 = 1, Vcc = 5.0 V	_	0.9	-	μΑ
td(E-A)	Waiting time until voltage detection circuit operation starts ⁽²⁾		-	=	300	μS
Vccmin	MCU operating voltage minimum value		2.2	=	-	V

- 1. The measurement condition is Vcc = 2.2 to 5.5 V and Topr = -20 to 85°C (N version) / -40 to 85°C (D version).
- 2. Necessary time until the voltage detection circuit operates when setting to 1 again after setting the VCA25 bit in the VCA2 register to 0.

Table 5.7 **Voltage Detection 1 Circuit Electrical Characteristics**

Symbol	Parameter	Condition		Unit		
Syllibol	Farameter	Condition	Min.	Тур.	Max.	Offic
Vdet1	Voltage detection level ⁽⁴⁾		2.70	2.85	3.00	V
_	Voltage monitor 1 interrupt request generation time ⁽²⁾		_	40	_	μS
=	Voltage detection circuit self power consumption	VCA26 = 1, Vcc = 5.0 V	-	0.6	-	μΑ
td(E-A)	Waiting time until voltage detection circuit operation starts ⁽³⁾		=	-	100	μS

- 1. The measurement condition is Vcc = 2.2 to 5.5 V and Topr = -20 to 85°C (N version) / -40 to 85°C (D version).
- 2. Time until the voltage monitor 1 interrupt request is generated after the voltage passes Vdet1.
- 3. Necessary time until the voltage detection circuit operates when setting to 1 again after setting the VCA26 bit in the VCA2 register to 0.
- 4. This parameter shows the voltage detection level when the power supply drops. The voltage detection level when the power supply rises is higher than the voltage detection level when the power supply drops by approximately 0.1 V.

Table 5.8 **Voltage Detection 2 Circuit Electrical Characteristics**

Symbol	Parameter	Condition		Unit		
Syllibol	Farameter	Condition	Min.	Тур.	Max.	Offic
Vdet2	Voltage detection level		3.3	3.6	3.9	V
-	Voltage monitor 2 interrupt request generation time ⁽²⁾		_	40	_	μS
=	Voltage detection circuit self power consumption	VCA27 = 1, Vcc = 5.0 V	-	0.6	-	μΑ
td(E-A)	Waiting time until voltage detection circuit operation starts ⁽³⁾		-	=	100	μ\$

- 1. The measurement condition is Vcc = 2.2 to 5.5 V and Topr = -20 to 85°C (N version) / -40 to 85°C (D version).
- $2. \ \ \text{Time until the voltage monitor 2 interrupt request is generated after the voltage passes V_{det2}.}$
- 3. Necessary time until the voltage detection circuit operates after setting to 1 again after setting the VCA27 bit in the VCA2 register to 0.



Table 5.10 High-speed On-Chip Oscillator Circuit Electrical Characteristics

Symbol	Parameter	Condition		Standard		Unit
	Parameter	Condition	Min.	Тур.	Max.	Unit
fOCO40M	High-speed on-chip oscillator frequency	Vcc = 4.75 to 5.25 V	39.2	40	40.8	MHz
	temperature • supply voltage dependence	$0^{\circ}C \leq T_{opr} \leq 60^{\circ}C^{(2)}$				
		Vcc = 3.0 to 5.5 V	38.8	40	41.2	MHz
		-20 °C $\leq T_{opr} \leq 85$ °C ⁽²⁾				
		Vcc = 3.0 to 5.5 V	38.4	40	41.6	MHz
		$-40^{\circ}C \leq T_{opr} \leq 85^{\circ}C^{(2)}$				
		Vcc = 2.7 to 5.5 V	38	40	42	MHz
		-20 °C \leq Topr \leq 85°C ⁽²⁾				
		Vcc = 2.7 to 5.5 V	37.6	40	42.4	MHz
		-40 °C \leq Topr \leq 85°C(2)				
		Vcc = 2.2 to 5.5 V	35.2	40	44.8	MHz
		-20 °C \leq Topr \leq 85°C(3)				
		Vcc = 2.2 to 5.5 V	34	40	46	MHz
		-40 °C \leq Topr \leq 85°C(3)				
		$Vcc = 5.0 V \pm 10\%$	38.8	40	40.8	MHz
		-20 °C \leq Topr \leq 85°C ⁽²⁾				
		$Vcc = 5.0 V \pm 10\%$	38.4	40	40.8	MHz
		-40 °C \leq Topr \leq 85°C(2)				
	High-speed on-chip oscillator frequency when	Vcc = 5.0 V, Topr = 25°C	_	36.864	_	MHz
	correction value in FRA7 register is written to	Vcc = 3.0 to 5.5 V	-3%	-	3%	%
	FRA1 register ⁽⁴⁾	-20°C ≤ Topr ≤ 85°C				
_	Value in FRA1 register after reset		08h ⁽³⁾	_	F7h ⁽³⁾	_
=	Oscillation frequency adjustment unit of high-	Adjust FRA1 register	-	+0.3	_	MHz
	speed on-chip oscillator	(value after reset) to -1				
_	Oscillation stability time		_	10	100	μS
_	Self power consumption at oscillation	Vcc = 5.0 V, Topr = 25°C	-	400	_	μΑ

- 1. Vcc = 2.2 to 5.5 V, $T_{opr} = -20$ to $85^{\circ}C$ (N version) / -40 to $85^{\circ}C$ (D version), unless otherwise specified.
- 2. These standard values show when the FRA1 register value after reset is assumed.
- 3. These standard values show when the corrected value of the FRA6 register is written to the FRA1 register.
- 4. This enables the setting errors of bit rates such as 9600 bps and 38400 bps to be 0% when the serial interface is used in UART mode.

Table 5.11 Low-speed On-Chip Oscillator Circuit Electrical Characteristics

Symbol	Parameter	Condition		Unit		
		Condition	Min.	Тур.	Max.	Unit
fOCO-S	Low-speed on-chip oscillator frequency		30	125	250	kHz
_	Oscillation stability time		-	10	100	μS
_	Self power consumption at oscillation	Vcc = 5.0 V, Topr = 25°C	-	15	-	μА

NOTE:

1. Vcc = 2.2 to 5.5 V, $T_{opr} = -20$ to $85^{\circ}C$ (N version) / -40 to $85^{\circ}C$ (D version), unless otherwise specified.

Table 5.12 Power Supply Circuit Timing Characteristics

Symbol	Parameter	Condition	,	Unit		
		Condition	Min.	Тур.	Max.	Uill
td(P-R)	Time for internal power supply stabilization during power-on ⁽²⁾		1	=	2000	μS
td(R-S)	STOP exit time ⁽³⁾		=	-	150	μS

- 1. The measurement condition is Vcc = 2.2 to 5.5 V and Topr = 25°C.
- 2. Waiting time until the internal power supply generation circuit stabilizes during power-on.
- 3. Time until system clock supply starts after the interrupt is acknowledged to exit stop mode.



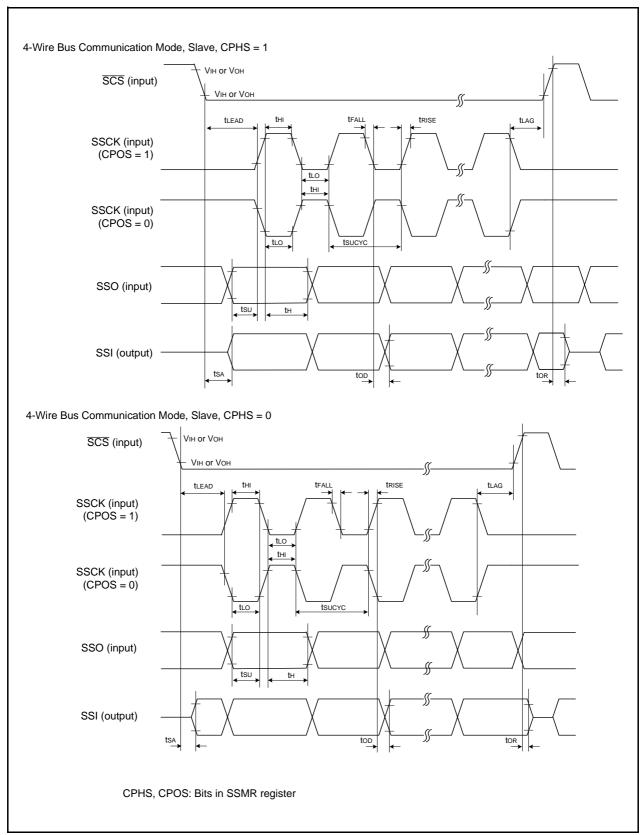


Figure 5.5 I/O Timing of Clock Synchronous Serial I/O with Chip Select (Slave)

Table 5.23 Electrical Characteristics (4) [Vcc = 3 V] (Topr = -20 to 85°C (N version) / -40 to 85°C (D version), unless otherwise specified.)

Symbol	Parameter	Parameter Condition			Standard		
Symbol	Parameter		Condition	Min.	Тур.	Max.	Unit
Icc	Power supply current (Vcc = 2.7 to 3.3 V) Single-chip mode, output pins are open,	High-speed clock mode	XIN = 10 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division	-	6	=	mA
	other pins are Vss		XIN = 10 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8	1	2	_	mA
		High-speed on-chip oscillator mode	XIN clock off High-speed on-chip oscillator on fOCO = 10 MHz Low-speed on-chip oscillator on = 125 kHz No division		5	9	mA
		mode	XIN clock off High-speed on-chip oscillator on fOCO = 10 MHz Low-speed on-chip oscillator on = 125 kHz Divide-by-8	_	2	_	mA
		Low-speed on-chip oscillator mode	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8, FMR47 = 1	-	130	300	μА
		Low-speed clock mode	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off XCIN clock oscillator on = 32 kHz FMR47 = 1	-	130	300	μА
			XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off XCIN clock oscillator on = 32 kHz Program operation on RAM Flash memory off, FMSTP = 1	I	30	-	μА
		Wait mode	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz While a WAIT instruction is executed Peripheral clock operation VCA27 = VCA26 = VCA25 = 0 VCA20 = 1	_	25	70	μА
			XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz While a WAIT instruction is executed Peripheral clock off VCA27 = VCA26 = VCA25 = 0 VCA20 = 1	-	23	55	μА
			XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off XCIN clock oscillator on = 32 kHz (high drive) While a WAIT instruction is executed VCA27 = VCA26 = VCA25 = 0 VCA20 = 1	=	3.8	=	μА
			XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off XCIN clock oscillator on = 32 kHz (low drive) While a WAIT instruction is executed VCA27 = VCA26 = VCA25 = 0 VCA20 = 1	=	2.0	=	μА
		Stop mode	XIN clock off, Topr = 25°C High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1 Peripheral clock off VCA27 = VCA26 = VCA25 = 0	-	0.7	3.0	μА
			XIN clock off, Topr = 85°C High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1 Peripheral clock off VCA27 = VCA26 = VCA25 = 0	-	1.1	_	μА

Timing requirements

(Unless Otherwise Specified: Vcc = 2.2 V, Vss = 0 V at Topr = 25°C) [Vcc = 2.2 V]

Table 5.30 XIN Input, XCIN Input

Symbol	Parameter		Standard		
			Max.	Unit	
tc(XIN)	XIN input cycle time	200	-	ns	
twh(xin)	XIN input "H" width	90	-	ns	
tWL(XIN)	XIN input "L" width	90	-	ns	
tc(XCIN)	XCIN input cycle time	14	Ī	μS	
twh(xcin)	XCIN input "H" width	7	Ī	μS	
twl(xcin)	XCIN input "L" width	7	-	μS	

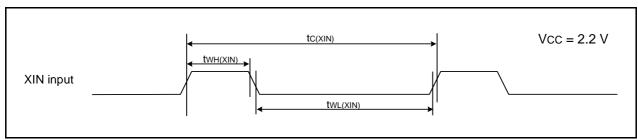


Figure 5.16 XIN Input and XCIN Input Timing Diagram when Vcc = 2.2 V

Table 5.31 TRAIO Input

Symbol	Parameter		Standard		
			Max.	Unit	
tc(TRAIO)	TRAIO input cycle time	500	=	ns	
twh(traio)	TRAIO input "H" width	200	=	ns	
twl(traio)	TRAIO input "L" width	200	=	ns	

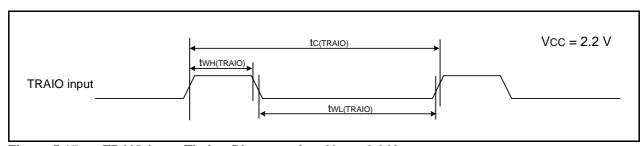


Figure 5.17 TRAIO Input Timing Diagram when Vcc = 2.2 V

Table 5.32 Serial Interfa	ace	Interfa	Serial	.32	able	٦
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Symbol	Parameter	Stan	Unit	
	Parameter		Max.	Offic
tc(CK)	CLK0 input cycle time	800	=	ns
tW(CKH)	CLK0 input "H" width	400	-	ns
tW(CKL)	CLK0 input "L" width	400	-	ns
td(C-Q)	TXDi output delay time	=	200	ns
th(C-Q)	TXDi hold time	0	-	ns
tsu(D-C)	RXDi input setup time	150	=	ns
th(C-D)	RXDi input hold time	90	-	ns

i = 0 or 1

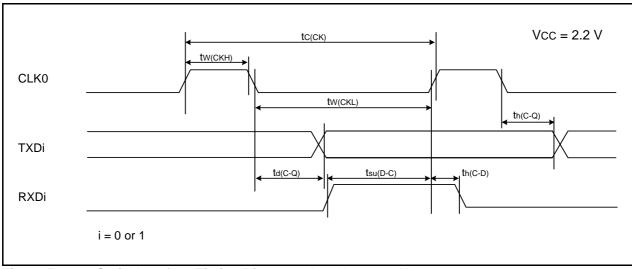


Figure 5.18 Serial Interface Timing Diagram when Vcc = 2.2 V

Table 5.33 External Interrupt \overline{INTi} (i = 0, 1, 3) Input

Symbol Parameter	Parameter	Stan	Unit	
	raidilletei	Min.	Max.	Offic
tW(INH)	INTi input "H" width	1000(1)	-	ns
tw(INL)	INTi input "L" width	1000 ⁽²⁾	-	ns

- 1. When selecting the digital filter by the INTi input filter select bit, use an INTi input HIGH width of either (1/digital filter clock frequency × 3) or the minimum value of standard, whichever is greater.
- 2. When selecting the digital filter by the INTi input filter select bit, use an INTi input LOW width of either (1/digital filter clock frequency × 3) or the minimum value of standard, whichever is greater.

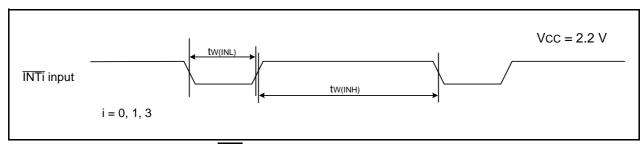
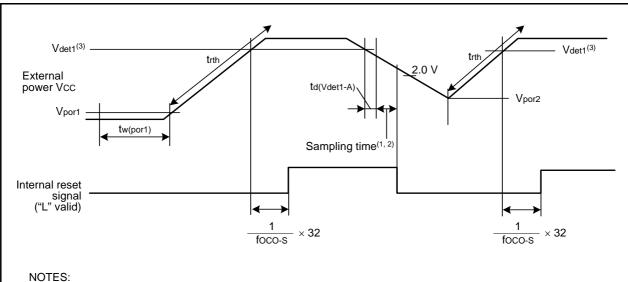


Figure 5.19 External Interrupt INTi Input Timing Diagram when Vcc = 2.2 V

Table 5.41	Power-on Reset Circuit.	Voltage Monitor 1 Reset Electrical Characteristics (3)
	i dirai dii itaaat dii dait,	Tollage melliter i recoot Electrical characteriotics

Symbol	Parameter	Condition		Unit		
		Condition	Min.	Тур.	Max.	Offic
Vpor1	Power-on reset valid voltage ⁽⁴⁾		_	-	0.1	V
Vpor2	Power-on reset or voltage monitor 1 reset valid voltage		0	_	Vdet1	V
trth	External power Vcc rise gradient	Vcc ≤ 3.6 V	20(2)	-	_	mV/msec
		Vcc > 3.6 V	20(2)	=	2,000	mV/msec

- 1. The measurement condition is Topr = -40 to 85°C (J version) / -40 to 125°C (K version), unless otherwise specified.
- 2. This condition (the minimum value of external power Vcc rise gradient) does not apply if $V_{por2} \ge 1.0 \text{ V}$.
- 3. To use the power-on reset function, enable voltage monitor 1 reset by setting the LVD1ON bit in the OFS register to 0, the VW1C0 and VW1C6 bits in the VW1C register to 1 respectively, and the VCA26 bit in the VCA2 register to 1.
- 4. tw(por1) indicates the duration the external power Vcc must be held below the effective voltage (Vpor1) to enable a power on reset. When turning on the power for the first time, maintain tw(por1) for 30 s or more if -20°C ≤ Topr ≤ 125°C, maintain tw(por1) for 3,000 s or more if -40°C ≤ Topr < -20°C.</p>



- 1. When using the voltage monitor 1 digital filter, ensure VCC is 2.0 V or higher during the sampling time.
- 2. The sampling clock can be selected. Refer to 6. Voltage Detection Circuit of Hardware Manual for details.
- 3. V_{det1} indicates the voltage detection level of the voltage detection 1 circuit. Refer to **6. Voltage Detection** Circuit of Hardware Manual for details.

Figure 5.22 Reset Circuit Electrical Characteristics

Table 5.42 High-speed On-Chip Oscillator Circuit Electrical Characteristics

Symbol	Parameter	Condition		Standard			
Symbol		Condition	Min.	Тур.	Max.	Unit	
fOCO40M	High-speed on-chip oscillator frequency temperature • supply voltage dependence	Vcc = 4.75 to 5.25 V 0° C \leq Topr \leq 60° C ⁽²⁾	39.2	40	40.8	MHz	
		Vcc = 3.0 to 5.5 V -20°C \leq Topr \leq 85°C ⁽²⁾	38.8	40	41.2	MHz	
		Vcc = 3.0 to 5.5 V -40°C \leq Topr \leq 85°C ⁽²⁾	38.4	40	41.6	MHz	
		Vcc = 3.0 to 5.5 V -40°C \leq Topr \leq 125°C ⁽²⁾	38	40	42	MHz	
		Vcc = 2.7 to 5.5 V -40°C \leq Topr \leq 125°C ⁽²⁾	37.6	40	42.4	MHz	
_	Value in FRA1 register after reset		08h	-	F7h	_	
_	Oscillation frequency adjustment unit of high- speed on-chip oscillator	Adjust FRA1 register (value after reset) to -1	-	+0.3	_	MHz	
=-	Oscillation stability time		-	10	100	μS	
=-	Self power consumption at oscillation	Vcc = 5.0 V, Topr = 25°C	-	400	-	μΑ	

- 1. Vcc = 2.7 to 5.5 V, Topr = -40 to $85^{\circ}C$ (J version) / -40 to $125^{\circ}C$ (K version), unless otherwise specified.
- 2. These standard values show when the FRA1 register value after reset is assumed.

Table 5.43 Low-speed On-Chip Oscillator Circuit Electrical Characteristics

Symbol	Parameter	Condition		Unit		
		Condition	Min.	Тур.	Max.	Offic
fOCO-S	Low-speed on-chip oscillator frequency		40	125	250	kHz
=	Oscillation stability time		=	10	100	μS
_	Self power consumption at oscillation	Vcc = 5.0 V, Topr = 25°C	=	15	1	μА

NOTE:

Table 5.44 Power Supply Circuit Timing Characteristics

Symbol	Parameter	Condition	Standard			Unit
Symbol	Falametei	Condition	Min.	Тур.	Max.	Offic
td(P-R)	Time for internal power supply stabilization during power-on ⁽²⁾		1	=	2000	μ\$
td(R-S)	STOP exit time ⁽³⁾		-	-	150	μS

- 1. The measurement condition is Vcc = 2.7 to 5.5 V and T_{opr} = 25°C.
- 2. Waiting time until the internal power supply generation circuit stabilizes during power-on.
- 3. Time until system clock supply starts after the interrupt is acknowledged to exit stop mode.

^{1.} Vcc = 2.7 to 5.5 V, Topr = -40 to $85^{\circ}C$ (J version) / -40 to $125^{\circ}C$ (K version), unless otherwise specified.

REVISION HISTORY

R8C/28 Group, R8C/29 Group Datasheet

	Б. /		Description	
Rev.	Date	Page	Summary	
0.10	Nov 14, 2005	_	First Edition issued	
0.30	Feb 28, 2006	all pages	"J, K version" added	
		1	1.1 Applications revised	
		2	Table 1.1 Functions and Specifications for R8C/28 Group revised	
		3	Table 1.2 Functions and Specifications for R8C/29 Group revised	
		4	Figure 1.1 Block Diagram; NOTE3 added	
		5	Table 1.3 Product Information for R8C/28 Group and Figure 1.2 Type Number, Memory Size, and Package of R8C/28 Group revised	
		6	Table 1.4 Product Information for R8C/29 Group and Figure 1.3 Type Number, Memory Size, and Package of R8C/29 Group revised	
		7	Figure 1.4 Pin Assignments (Top View); NOTE3 added	
		8	Table 1.5 Pin Functions revised	
		9	Table 1.6 Pin Name Information by Pin Number; "XOUT" \to "XOUT/XCOUT", "XIN" \to "XIN/XCIN" revised and NOTE2 added	
		13	Figure 3.1 Memory Map of R8C/28 Group; "R5F21284JSP, R5F21284KSP" added	
		14	Figure 3.2 Memory Map of R8C/29 Group; "R5F21294JSP, R5F21294KSP" added	
		15	Table 4.1 SFR Information (1); NOTE6 added	
		18	Table 4.4 SFR Information (4); 00FEh: "DRR" → "P1DRR" symbol name revised	
		22 to 66	5. Electrical Characteristics added	
0.40	Mar 29, 2006	2	Table 1.1 Functions and Specifications for R8C/28 Group revised	
		3	Table 1.2 Functions and Specifications for R8C/29 Group revised	
		15	Table 4.1 SFR Information (1); - 0032h, 0036h, 0038h revised	
			- NOTES 2 to 6 revised and NOTES 7 to 8 added	
		19	Table 4.5 SFR Information (5); NOTE2 added	
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		1	1 "J and K versions are under developmentnotice." added	
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